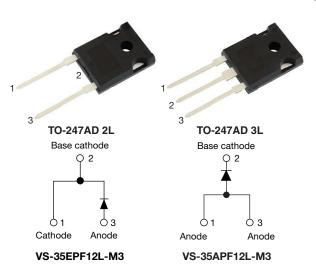


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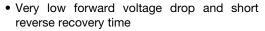
Vishay Semiconductors

Fast Soft Recovery Rectifier Diode, 35 A



| PRIMARY CHARACTERISTICS | | | | |
|----------------------------------|--------------------------|--|--|--|
| I _{F(AV)} | 35 A | | | |
| V_{R} | 1200 V | | | |
| V _F at I _F | 1.27 V | | | |
| I _{FSM} | 350 A | | | |
| t _{rr} | 95 ns | | | |
| T _J max. | 150 °C | | | |
| Package | TO-247AD 2L, TO-247AD 3L | | | |
| Circuit configuration | Single | | | |
| Snap factor | 0.6 | | | |

FEATURES





- · Glass passivated pellet chip junction
- Designed and qualified according to JEDEC® - JESD 47
- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- AEC-Q101 qualified P/N available (VS-35EPF12LHM3, VS-35APF12LHM3)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-35EPF12L-M3 and VS-35APF12L-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

| MAJOR RATINGS AND CHARACTERISTICS | | | | | | |
|-----------------------------------|------------------------------|-------------|-------|--|--|--|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS | | | |
| I _{F(AV)} | Sinusoidal waveform | 35 | A | | | |
| V _{RRM} | | 1200 | V | | | |
| I _{FSM} | | 350 | A | | | |
| V _F | 15 A, T _J = 25 °C | 1.27 | V | | | |
| t _{rr} | 1 A, 100 A/μs | 95 | ns | | | |
| TJ | | -40 to +150 | °C | | | |

| VOLTAGE RATINGS | | | | | |
|-----------------|---|---|-------------------------------------|--|--|
| PART NUMBER | V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I _{RRM} AT 150 °C mA | | |
| VS-35EPF12L-M3 | 1200 | 1300 | 6 | | |
| VS-35APF12L-M3 | 1200 | 1300 | 0 | | |

VS-35EPF12L-M3, VS-35APF12L-M3

| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|--------------------------------------|--------------------|---|--------|------------------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Maximum average forward current | I _{F(AV)} | T _C = 102 °C, 180° conduction half sine wave | 35 | | | |
| Maximum peak one cycle | I _{FSM} | 10 ms sine pulse, rated V _{RRM} applied | 300 | А | | |
| non-repetitive surge current | | 10 ms sine pulse, no voltage reapplied | 350 | | | |
| Maximum I2t for fusing | I ² t | 10 ms sine pulse, rated V _{RRM} applied | 450 | A ² s | | |
| Maximum i-t for fusing | 1-1 | 10 ms sine pulse, no voltage reapplied 636 | | A-S | | |
| Maximum I ² √t for fusing | I ² √t | t = 0.1 ms to 10 ms, no voltage reapplied | 6360 | A²√s | | |

| ELECTRICAL SPECIFICATIONS | | | | | |
|-------------------------------------|--------------------|------------------------------|-------------------------|-------|----|
| PARAMETER | VALUES | UNITS | | | |
| Maximum forward voltage drop | V_{FM} | 35 A, T _J = 25 °C | | 1.47 | V |
| Forward slope resistance | r _t | T 150°C | | 10.09 | mΩ |
| Threshold voltage | V _{F(TO)} | T _J = 150 °C | | 0.992 | V |
| Maximum various la disease accurant | | T _J = 25 °C | \/ | 0.1 | mA |
| Maximum reverse leakage current | I _{RM} | T _J = 150 °C | V_R = rated V_{RRM} | 6 | MA |

| RECOVERY CHARACTERISTICS | | | | | |
|--------------------------|-----------------|--------------------------------------|--------|-------|-------------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | • |
| Reverse recovery time | t _{rr} | I _F at 30 A _{pk} | 450 | ns | I _{FM} + |
| Reverse recovery current | I _{rr} | 25 A/μs | 6.1 | Α | t _a t _b |
| Reverse recovery charge | Q _{rr} | 25 °C | 2.16 | μC | dir/dt Q _{rr} |
| Snap factor | S | Typical | 0.6 | | I I _{RM(REC)} |

| THERMAL - MEC | THERMAL - MECHANICAL SPECIFICATIONS | | | | | |
|--|---|-----------------------------------|---------------------------------------|-------------|------------|--|
| PARAMETER | | SYMBOL | TEST CONDITIONS | VALUES | UNITS | |
| Maximum junction and stemperature range | torage | T _J , T _{Stg} | | -40 to +150 | °C | |
| Maximum thermal resist unction to case | ance, | R _{thJC} | DC operation | 0.6 | | |
| Maximum thermal resist junction to ambient | Maximum thermal resistance, junction to ambient | | | 40 | °C/W | |
| Typical thermal resistant case to heatsink | Typical thermal resistance, case to heatsink | | Mounting surface, smooth, and greased | 0.25 | | |
| Annewimete weight | | | | 6 | g | |
| Approximate weight | | | | 0.21 | oz. | |
| Mounting torque | minimum | | | 6 (5) | kgf · cm | |
| Mounting torque | maximum | | | 12 (10) | (lbf ⋅ in) | |
| Madis de la | | | Case style TO-247AD 2L | 35EPI | F12L | |
| Marking device | | | Case style TO-247AD 3L | 35API | F12L | |



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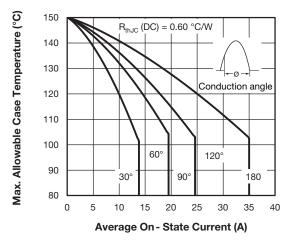


Fig. 1 - Current Rating Characteristics

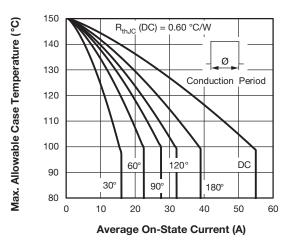


Fig. 2 - Current Rating Characteristics

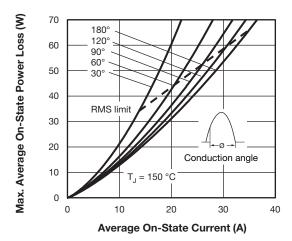


Fig. 3 - Forward Power Loss Characteristics

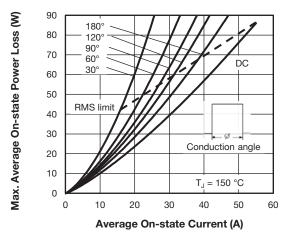


Fig. 4 - Forward Power Loss Characteristics

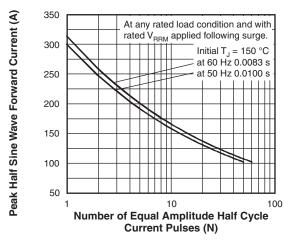


Fig. 5 - Maximum Non-Repetitive Surge Current

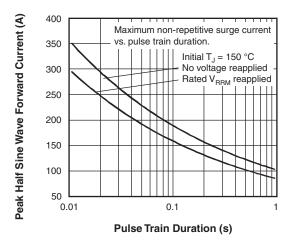


Fig. 6 - Maximum Non-Repetitive Surge Current



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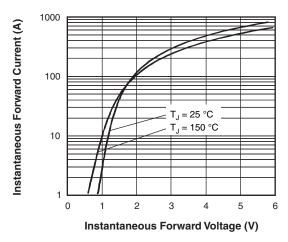


Fig. 7 - Forward Voltage Drop Characteristics

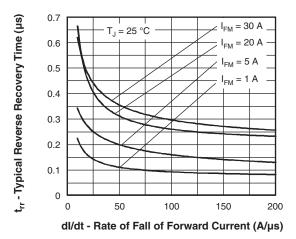


Fig. 8 - Thermal Impedance ZthJC Characteristics

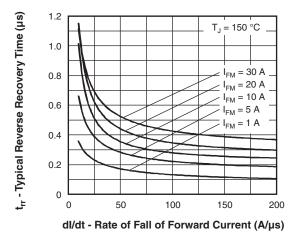


Fig. 9 - Recovery Time Characteristics, $T_J = 150~^{\circ}\text{C}$

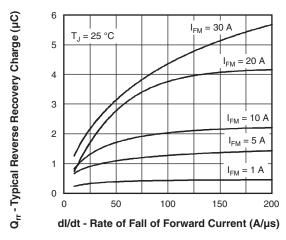


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

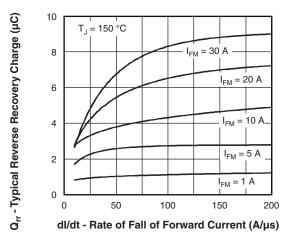


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

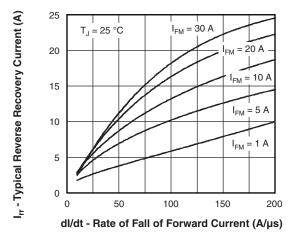


Fig. 12 - Recovery Current Characteristics, $T_J = 25\ ^{\circ}C$

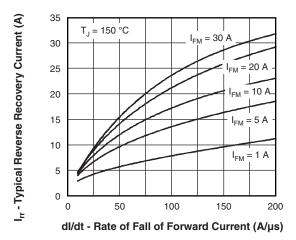


Fig. 13 - Recovery Current Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

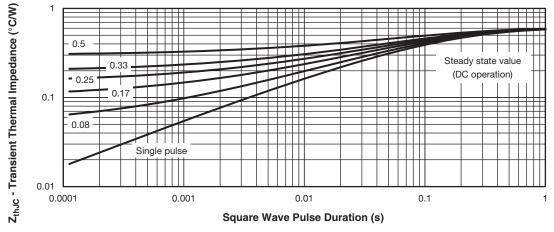
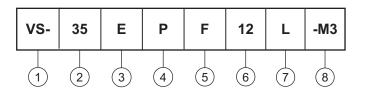


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (35 = 35 A)

3 - Circuit configuration:

E = single, 2 pins

A = single, 3 pins

- Package:

P = TO-247AD

5 - Type of silicon:

F = fast recovery rectifier

7 - L = long leads

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

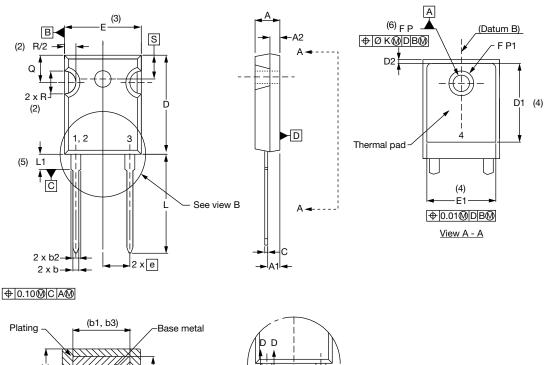
| ORDERING INFORMATION (Example) | | | | | |
|---|----|-----|--------------------------|--|--|
| PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION | | | | | |
| VS-35EPF12L-M3 | 25 | 500 | Antistatic plastic tubes | | |
| VS-35APF12L-M3 | 25 | 500 | Antistatic plastic tubes | | |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|-------------|--------------------------|--|--|
| Dimensions | TO-247AD 2L | www.vishay.com/doc?95536 | | |
| Dimensions - | TO-247AD 3L | www.vishay.com/doc?95626 | | |
| Dout moulding information | TO-247AD 2L | www.vishay.com/doc?95648 | | |
| Part marking information - | TO-247AD 3L | www.vishay.com/doc?95007 | | |

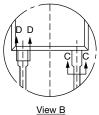


TO-247AD 2L

DIMENSIONS in millimeters and inches



| MILLIMETERS | INCHES | |
|-------------|----------------------------|--|
| | (4) <u>C - C, D - D</u> | |
| - | (b, b2) (4) | |
| (c) | c1 | |
| | | |



| SYMBOL | MILLIN | IETERS | INC | HES | NOTES |
|----------|--------|--------|-------|-------|-------|
| STINIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |
| D2 | 0.51 | 1.35 | 0.020 | 0.053 | |

| SYMBOL | MILLIN | MILLIMETERS | | HES | NOTES |
|----------|----------|-------------|----------|----------|-------|
| STINIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Е | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | - | 0.53 | - | |
| е | 5.46 | BSC | 0.215 | BSC | |
| ØK | 0.254 | | 0.0 | 10 | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 | BSC | |
| | | <u> </u> | <u> </u> | <u> </u> | · |

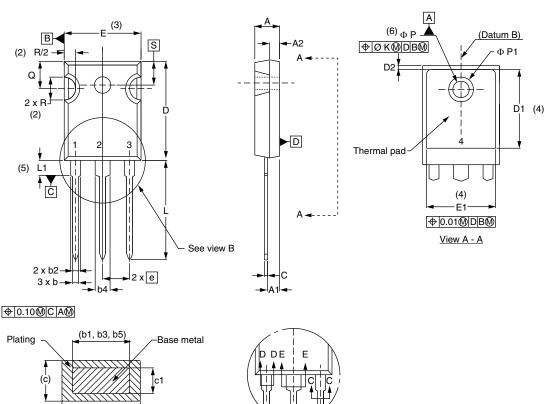
Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |

Section C - C, D - D, E - E

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | NOTES |
| D2 | 0.51 | 1.30 | 0.020 | 0.051 | |
| E | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | =. | 0.53 | - | |
| е | 5.46 BSC | | 0.215 BSC | | |
| ØK | 0.254 | | 0.010 | | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 BSC | | |
| | • | | | • | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4

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